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(54) Title: CURABLE SILICONE COMPOSITION AND CURED PRODUCT THEREOF

(57) Abstract: A curable silicone composition includes: (A) an organopolysiloxane represented by the siloxane unit formula (1) given below and having at least two univalent organic groups that contain epoxy groups and are free of aromatic rings: [R13SiO1/2]a [R<sup>2</sup><sub>2</sub>SiO<sub>2/2</sub>]<sub>b</sub> [R<sup>3</sup>SiO<sub>3/2</sub>]<sub>c</sub> (where R<sup>1</sup>, R<sup>2</sup>, and R<sup>3</sup> are univalent organic groups, at least two of which are univalent organic groups which contain epoxy groups and are free of aromatic rings; more than 20 mole % of R<sup>3</sup> are aryl groups; a + b + c &equals: 1; on average, "a" satisfies the following condition:  $0 \le a \le 0.8$ ; on average, "b" satisfies the following condition:  $0 \le b \le 0.8$ ; and, on average, "c" satisfies the following condition:  $0.2 \le c \le 1.0$ ); (B) a linear-chain organopolysiloxane having at least two univalent organic groups that contain phenolic hydroxyl groups; and (C) a curing accelerator.